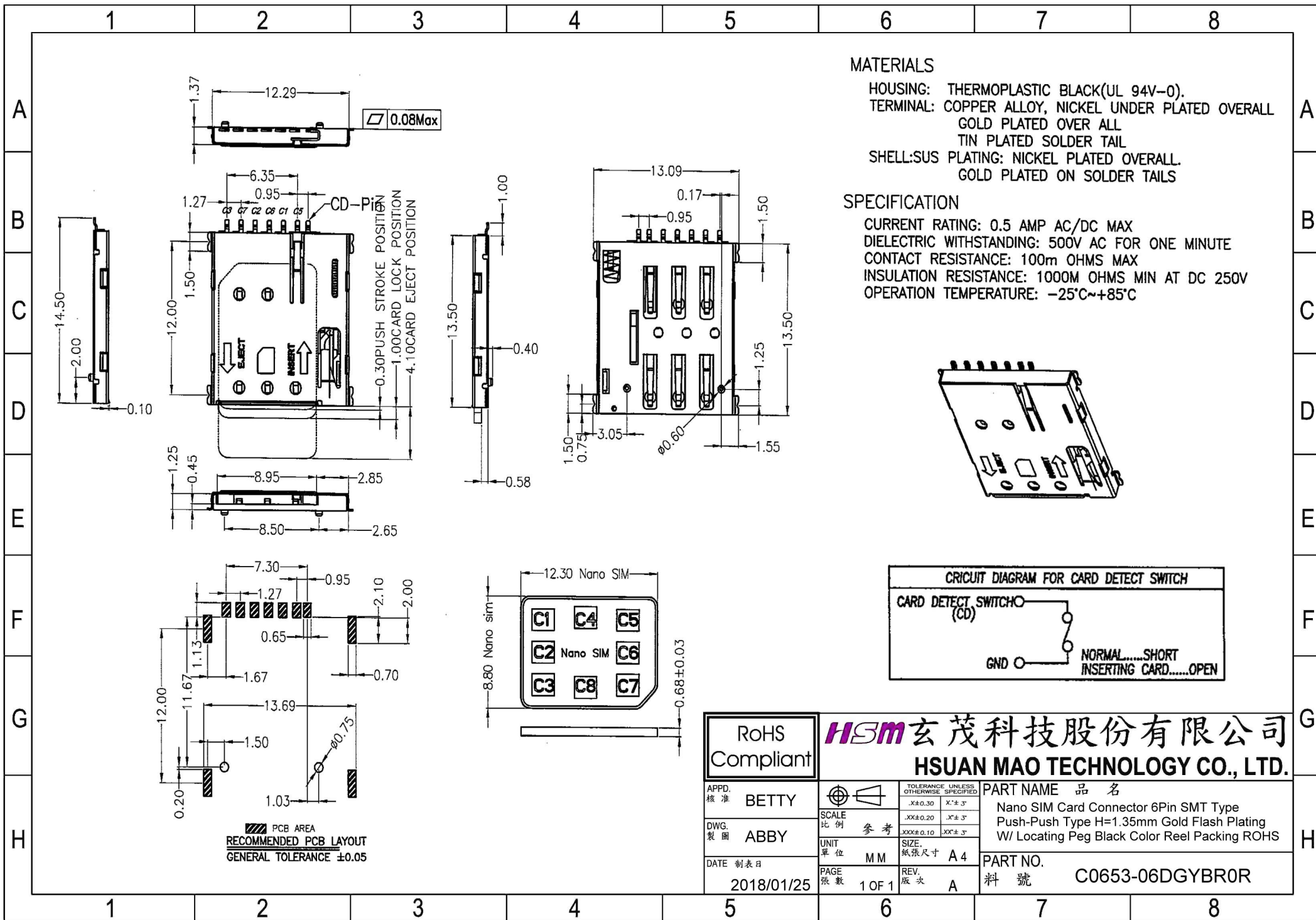


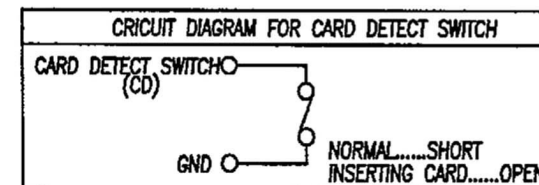
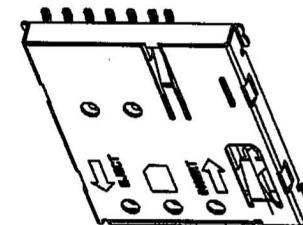


MATERIALS

HOUSING: THERMOPLASTIC BLACK(UL 94V-0).
TERMINAL: COPPER ALLOY, NICKEL UNDER PLATED OVERALL
GOLD PLATED OVER ALL
TIN PLATED SOLDER TAIL
SHELL:SUS PLATING: NICKEL PLATED OVERALL.
GOLD PLATED ON SOLDER TAILS

SPECIFICATION

CURRENT RATING: 0.5 AMP AC/DC MAX
DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
CONTACT RESISTANCE: 100m OHMS MAX
INSULATION RESISTANCE: 1000M OHMS MIN AT DC 250V
OPERATION TEMPERATURE: -25°C~+85°C



RoHS Compliant		HSM 玄茂科技股份有限公司	
		HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准	BETTY	SCALE 比例	参考
DWG. 製圖	ABBY	UNIT 單位	M M
DATE	制表日	PAGE 張數	1 OF 1
2018/01/25		REV. 版次	A
		PART NAME 品名	Nano SIM Card Connector 6Pin SMT Type Push-Push Type H=1.35mm Gold Flash Plating W/ Locating Peg Black Color Reel Packing ROHS
		PART NO. 料號	C0653-06DGYBR0R